

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re the Application of:

HEA-SUK JUNG

Application No.:

Filed:

For: **delay locked loop (dll) in semiconductor device**

Art Group:

Examiner:

**INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. §1.97**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In accordance with the duty of disclosure, enclosed is a copy of Information Disclosure Statement by Applicant (form PTO/SB/08), which is being submitted concurrently with the Utility Application. It is respectfully requested that the cited references be considered and that the enclosed copy of PTO/SB/08 be initialed by the Examiner to indicate such consideration and a copy thereof returned to applicant(s). Copies of the references cited on PTO/SB/08 are enclosed herewith.

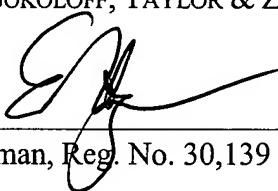
The submission of this Information Disclosure Statement is not to be construed as a representation that a search has been made in the subject application and is not to be construed as an admission that the information cited in this statement is material to patentability.

Please charge any fees due to Deposit Account 02-2666. A duplicate copy of the Fee Transmittal (PTO/SB/17) is enclosed for this purpose.

Date: 8/5/03

Respectfully submitted,

BLAKELY, SOKOLOFF, TAYLOR & ZAFMAN LLP

  
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Substitute for form 1449A/PTO				<i>Complete if Known</i>	
<b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b> <i>(use as many sheets as necessary)</i>				Application Number	
				Filing Date	
				First Named Inventor	Hea-Suk Jung
				Art Unit	
				Examiner Name	
Sheet	1	of	2	Attorney Docket Number	51876P367

## **INFORMATION DISCLOSURE STATEMENT BY APPLICANT**

*(use as many sheets as necessary)*

Sheet

1

of

2

**U.S. PATENT DOCUMENTS**

## **FOREIGN PATENT DOCUMENTS**

Examiner Signature		Date Considered	
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\*Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication.

<sup>1</sup>Applicant's unique citation designation number (optional). <sup>2</sup>See Kinds Codes of USPTO Patent Documents at [www.uspto.gov](http://www.uspto.gov) or MPEP 901.04. <sup>3</sup>Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>4</sup>For Japanese patent documents, the indication of the year of reign of the Emperor must precede the serial number of the patent document. <sup>5</sup>Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. <sup>6</sup>Applicant is to place a check mark here if English language Translation is attached.

**Substitute for form 1449A/PTO**

# **INFORMATION DISCLOSURE STATEMENT BY APPLICANT**

*(use as many sheets as necessary)*

Sheet 2 of 2

<i><b>Complete if Known</b></i>	
Application Number	
Filing Date	
First Named Inventor	Hea-Suk Jung
Art Unit	
Examiner Name	
Attorney Docket Number	51876P367

## **OTHER ART - NON PATENT LITERATURE DOCUMENTS**

Examiner Signature	Date Considered
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\*Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication.

<sup>1</sup>Applicant's unique citation designation number. <sup>2</sup>Applicant is to place a check mark here if English language Translation is attached.

Based on PTO/SB/08B (05-03) as modified by Blakely, Solokoff, Taylor & Zafman (wlr) 05/02/2003.  
Send To: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450

# **Information Disclosure Statement**

New U.S. Patent Application for  
DELAY LOCKED LOOP (DLL) IN SEMICONDUCTOR DEVICE  
Our Ref. No.: P03H1037/US/wy

Reference No.:

- (1) US Patent No. 6,552,955
- (2) US Patent No. 6,492,852
- (3) US Patent No. 6,075,395
- (4) US Publication No. 2003/0085744 A1
- (5) US Publication No. 2003/0081491 A1
- (6) US Publication No. 2003/0001637 A1
- (7) JP Laid-Open No. 2001-283589
- (8) JP Laid-Open No. 2000-100163
- (9) JP Laid-Open No. 11-259167
- (10) JP Laid-Open No. 11-214986
- (11) JP Laid-Open No. 11-72540